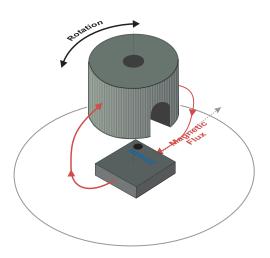
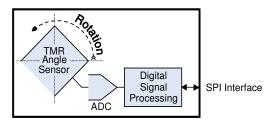


# **ASR002 Smart TMR Angle Sensor**

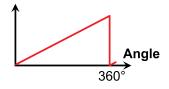


## **Block Diagram**



#### **Transfer Function**

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#### **Features**

- Measures rotational speeds to 375,000 RPM
- 3.3 volt or 5 volt compatible four-wire SPI interface
- Robust airgap and misalignment tolerances
- Factory calibrated
- Ultraminiature 2.5 x 2.5x 0.8 mm TDFN6 package

## **Key Specifications**

- 0.1° resolution
- ±0.2° repeatability
- Robust 60 to 200 Oe magnetic field operating range
- Fast 12.5 kSps sample rate
- Flexible 2.2 to 3.6 V supply range
- Low 4 mA typical supply current
- Full –40°C to +125°C operating range

#### **Applications**

- Rotary encoders
- Robotics
- Motor control
- Automotive applications
- Internet of Things (IoT) end nodes

#### **Description**

ASR002 TMR Smart Angle Sensors provide a precise digital angle measurement over a wide range of speeds.

The sensor combines precise, low-power Tunneling Magnetoresistance (TMR) sensing elements with sophisticated digital signal processing.

The sensor is factory calibrated, with coefficients stored in internal memory.

A four-wire SPI interface provides angle data and allows setting device parameters.

The ASR002 is designed for harsh industrial or automotive environments with ESD protection, and full -40°C to +125°C operating temperature range.





## **Boundary Ratings**

Parameter	Min.	Max.	Units	
Supply voltage	-12	4.2	Volts	
Input and output voltages (MISO, MOSI, SS, SCLK)	-0.5	V <sub>cc</sub> +2.5 up to 5.8	Volts	
Storage temperature	-55	150	°C	
ESD (Human Body Model)		2000	Volts	
Applied magnetic field		Unlimited	Oe	





## Operating Specifications ( $T_{min}$ to $T_{max}$ ; 2.2 < $V_{DD}$ < 3.6 V unless otherwise stated)

Parameter	Symbol	Min.	Тур.	Max.	Units	Test Condition
Operating temperature	T <sub>min</sub> ; T <sub>max</sub>	-40		125	°C	
Supply voltage	$V_{\scriptscriptstyle  m DD}$	2.2		3.6	V	
Supply current	$I_{\scriptscriptstyle DD}$		4	6	mA	Max. at $V_{DD} = 3.6V$
Power-on Reset supply voltage	$V_{POR}$		1.4		V	
Brown-out power supply voltage	$V_{BOR}$	0.75	1	1.36	V	
Start-up time	$T_{STA}$		1		ms	
Magnetics						
Applied magnetic field strength	Н	60		200	Oe	
Accuracy and Repeatability						
Angular resolution	δ		0.1			
Angular hysteresis	П			0.1		
Repeatability			±0.2		Angular	Fixed temperature and bias <sup>1</sup>
Angular accuracy, fixed bias <sup>1</sup>				±2 ±3	Degrees	0 to 85°C -40 to 125°C
Angular accuracy, variable bias <sup>2</sup>	- ε -			±6 ±6		25°C -40 to 125°C
Speed				_		
Sample rate			12.5		kSps	
SPI Bus Characteristics			-			
Bus voltage	$V_{\scriptscriptstyle BUS}$	2.2		5.5	V	
Low level input threshold voltage	V <sub>IL</sub>	0.8			V	
High level input threshold voltage	V <sub>IH</sub>			2.2	V	
Low level output current	$I_{OL}$	3			mA	$V_{OL} = 0.4 V$
I/O capacitance	C <sub>I/O</sub>			10	pF	
SPI Setup and Hold Timing			-			
Data transfer rate	DR			2	Mbits/s	Full duplex
SCLK Rise time	t <sub>R</sub>				ns	
SCLK fall time	$t_{\rm F}$				ns	
SCLK low time	$t_{\rm CL}$	200			ns	
SCLK fall time	t <sub>CH</sub>	200			ns	
SS to SCLK setup	$t_{SE}$	80			ns	
SCLK to MISO valid	$t_{ m SDD}$			170	ns	See figure 7
SS to MISO tri-state	$t_{\mathrm{SDZ}}$			170	ns	
SCLK to MOSI hold time	$t_{\mathrm{SDH}}$	80			ns	
MOSI to SCLK setup	$t_{SDS}$	80			ns	
SCLK to SS hold time	t <sub>SH</sub>	80			ns	
SS to MISO valid	t <sub>SEZ</sub>			170	ns	
RAM Timing						
Address setup time	$t_{ADDR}$			3	μs	See figure 4
Data read time	$t_{READ}$			10	μs	See figure 4
Nonvolatile Memory Characteristics						
Address setup time	t <sub>ADDR</sub>			3	μs	
Data read time	t <sub>READ</sub>			10	μs	See figure 5
Data write time	t <sub>NVM</sub>			20	ms	
Endurance			10000		Cycles	
Package Thermal Characteristics	Package Thermal Characteristics					
Junction-to-ambient thermal resistance	$\theta_{\scriptscriptstyle \mathrm{JA}}$		320		°C/W	
Package power dissipation			500		mW	





## **Specification Notes:**

- 1. "Fixed Bias" means a fixed airgap within between the bias magnet and sensor so the magnitude of the magnetic field at the sensor is constant within the specified field range of the parts. The highest accuracy is obtained using fields closest to factory calibration.
- 2. "Variable Bias" means the magnitude of the magnetic field at the sensor can vary across the entire specification range.



## ASR002Overview

The ASR002 is a non-contact angle sensor designed for high speed applications where size is limited. The heart of the ASR002 is a tunneling magnetoresistive (TMR) sensor. In a typical configuration, an external magnet provides a magnetic field of 30 to 200 Oe in the plane of the sensor, as illustrated below for a bar magnet and a diametrically-magnetized disk magnet. Factory-programmed signal conditioning is combined with a temperature sensor and digital linearization to produce high speed, accuracy, and precision in a tiny 2.5 x 2.5 mm TDFN package.

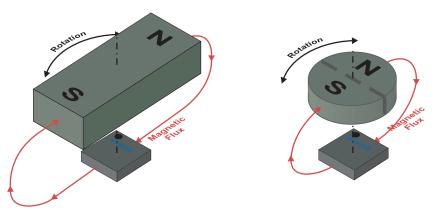


Figure 1. Sensor operation.

#### **ASR002Operation**

A detailed block diagram is shown below:

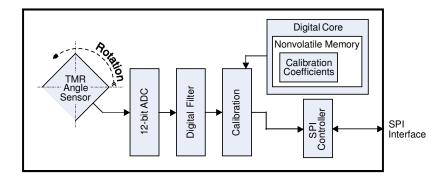


Figure 2. Detailed block diagram.

## TMR Angle Sensor Element

ASR002 sensors use unique TMR sensor elements that are inherently high speed and low noise. The digital core calculates the angle from sensor element Sine and Cosine vectors, and the raw sensor data are available from separate memory locations.

#### **ADC**

The sensor output is digitized with a 12-bit ADC. The extra bits ensure precision and computational accuracy.

#### Digital Filter

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A first-order Infinite Impulse Response (IIR) digital filter with a programmable cutoff frequency can be used for ultralow noise if high-frequency operation is required. The factory default is the filter turned off.

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#### **Rotation Direction**

The ASR002 can provide increasing angle values for either clockwise or counterclockwise field rotations. Counterclockwise is defined as a rotating field vector through pins 1-3-4-6, and clockwise through pins 1-6-4-3. The rotation direction can be programmed using the  $\theta_{DIR}$  parameter.



Figure 3. Zero-angle reference  $(\theta_0)$  and rotation direction  $(\theta_{DIR})$ . The rotational center of the sensor is the package center.

#### Zero-Angle Reference Point

A programmable parameter  $\theta_0$  sets the zero-degree reference or angular offset. This is the angle of "discontinuity," that is, where the angle output changes from 360° to 0°. The default  $\theta_0$  value is zero for magnetic fields pointing from pin 1 to pin 6.

#### Direction and Hysteresis

The Direction output indicates direction of rotation. A hysteresis setting can be changed to prevent small changes from causing the Direction output to "chatter," especially at low speed.

#### Digital Filter

The digital filter is an Infinite impulse response (IIR) weighted running average filter, which can reduce mechanical and electrical noise depending on the required speed.

The filtered output is calculated as follows:

$$\theta_n = \theta/m + [(m-1)/m]\theta_{n-1}$$

Where  $\theta$  = is the measured angle;  $\theta_n$  = the filtered angle;  $\theta_{n-1}$  is the previous value of the filtered angle; and m is a constant that determines the cutoff frequency as follows:

$$f_{CLITOFE} = f_{SAMPLE}/(2\pi \text{ m})$$

Where  $f_{\text{CUTOFF}}$  is the filter cutoff frequency and  $f_{\text{SAMPLE}}$  is the sensor ADC sampling rate (approximately 12500/s). So for example, if m = 10, the cutoff frequency is approximately 200 Hz.

m = 1 disables filter so the output is simply updated with each sample.

### A Simple SPI Interface

The SPI interface is an industry standard four-wire, full-duplex 2 megabit per second connection with the sensor as the slave to an external master such as a microcontroller. SPI data (MOSI and MISO) and the Clock (SCLK) are 2.2 volt to five-volt compliant. The digital angle is the default two byte response.

The ASR002 uses an industry-standard "Mode 0" interface (data is sampled at the leading rising edge of the clock; CPOL=0 and CPHA=0). In accordance with industry standards, slave select (SS) is active-low, and bit order and byte order are from MSB to LSB.

Details are shown in the following diagrams:







Figure 4b. Reading data.



MOSI Address A

Figure 6. Continuous read.

**NVE** Corporation



SPI setup and hold timing constraints are shown in Figure 7:

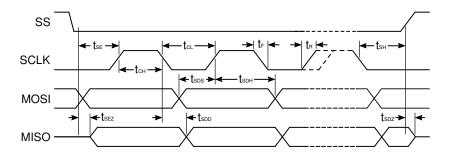


Figure 7. SPI setup and hold timing.

A schematic of a typical interface to a 3.3-volt or five-volt microcontroller is show in the Applications section.

## **Straightforward Reading and Writing**

The sensor is reset on a falling edge of SS. All reads and writes are initiated by the master pulling SS "LOW" and sending an eight-bit address to the ASR002 plus a second byte. The least significant bit of the second address byte indicates whether the address request is for a read or a write ("0" is a read; "1" is a write). The slave responds with two bytes of data.

As shown in figures 4 and 5, and the specification table, a 3  $\mu$ s delay ( $t_{ADDR}$ ) is needed between address bytes; 10  $\mu$ s ( $t_{READ}$ ) should be allowed before data can be read, and 20 ms ( $t_{NVM}$ ) should be allowed for writing parameters to the nonvolatile memory.

The angle is stored in Address 0 of the sensor, and reading the angle is a simple four-byte sequence. The master writes the two zero bytes for the "0" angle address, and reads the two-byte angle, which is expressed in tenths of degrees. This can be repeated to continuously read the angle as shown in Figure 6.

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Memory Map

The ASR002 memory provides access to angle data and user-programmable parameters. The memory is accessed via SPI as described in the SPI interface section.

Parameter	Symbol	Default	Read/ Write	Range	Address	Description	
	Data						
Angle	θ			0 - 3600	0x00	In tenths of a degree	
Raw Sin Vector	Sinθ			Approx.	0x01	Raw outputs centered at approx.	
Raw Cos Vector	Cosθ	N/A	R	1500 – 2500	0x02	2048 with peak-peak amplitudes of approx. 1000.	
Direction	Dir			0 – 1	0x03	0 = decreasing angle 1 = increasing angle	
	User-Programmable Parameters						
Rotation Direction	$\theta_{ m DIR}$	0		0 – 1	0x40 [bit 0]	0 → increasing CCW; 1 → increasing CW (see Fig. 3)	
Angular Offset	$\theta_0$	0	R/W	0 – 3600	0x41 [bits 13:0]	Point at which angle is zero (see Fig. 3)	
Digital Filter Constant	m	0	K/W	1 – 255	0x42	$f_{\text{CUTOFF}} = f_{\text{SAMPLE}}/(2\pi \text{ m});$ $f_{\text{SAMPLE}} = \text{approx. } 12.5 \text{ kSps}$ m = 1  disables filter	
Direction Hysteresis	$\delta_{ m DIR}$	25		0 - 255 $(0 - 25.5^{\circ})$	0x43	Hysteresis of the "Dir" output; in tenths of a degree	
Read-Only Memory							
Lot code			R		0x80 – 0x85	Date code in ASCII; right-most character in address 80; left-most in address 85; format YYWWXX, where  YY = year;  WW = work week;  XX = internal code.	

Table 1. ASR002 Memory Locations.

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#### **Power-Up and Initialization**

## Absolute position

Unlike some encoder types, ASR002 sensors detect absolute position and maintain position information when the power is removed. The sensor powers up indicating the correct position.

#### Nonvolatile parameters

All parameters are nonvolatile so they can be set once (via SPI), and remain for the life of the product if desired.

#### Minimizing Noise

Several steps allow taking advantage of ASR002's inherent low noise:

- V<sub>DD</sub> should be bypassed with a 1 μF/6.3 V capacitor (preferably nonmagnetic) placed as close as possible to the V<sub>DD</sub> and GND pins. 10 μF can be used in noisy environments or if the capacitor can't be located close to the sensor. Inadequate bypassing can cause noise or anomalous device behavior.
- Use a circuit board ground plane.
- Ground the sensor's center pad so the leadframe acts as a shield.

#### Minimizing Magnetic Interference

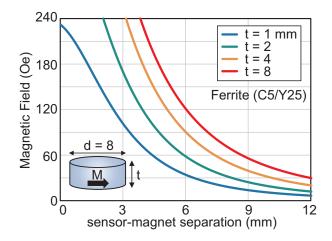
Several precautions can be taken for applications that need maximum accuracy:

- Components such as resistors and capacitors can be slightly magnetic, and should be located away from the sensor if possible.
- Moving the bypass capacitor away from the sensor may lead to noise problem, but a larger bypass capacitor (e.g., 10 μF) can often compensate for longer traces.
- If components must be located near the sensor, ultrasmall components such as 0201 (0603 metric) contain less ferromagnetic material than larger components.
- The bypass capacitor can be located on the opposite side of the board directly underneath the sensor to minimize asymmetrical field distortions.
- Nonmagnetic resistors and capacitors can be used for extremely sensitive applications. Nonmagnetic 1 μF capacitors may not be available, but a 0.1 μF bypass capacitor can be used in applications not subject to significant noise.



#### **Magnet Selection**

The sensor's wide operating field range of 60 to 200 Oe allows inexpensive magnets and operation over a wide range of magnet spacing. The figures below show the magnetic field for various magnet geometries and distances for inexpensive C5/Y25 grade ferrite magnets:



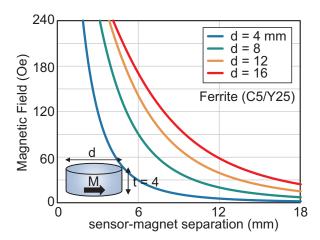


Figure 8. Magnetic fields for various geometries of C5/Y25 ferrite magnets plotted for the distance between the magnet and sensor. Eight-millimeter diameter magnets of various thicknesses are shown at left, and four-millimeter thick magnets of various diameters are shown at right.

Field varies less with distance for larger magnets, so maximizing magnet size within the mechanical constraints of the system maximizes accuracy.

Higher-grade magnets can be used for high-temperature applications or large magnet-sensor separations. The graph below shows field strengths with various materials:

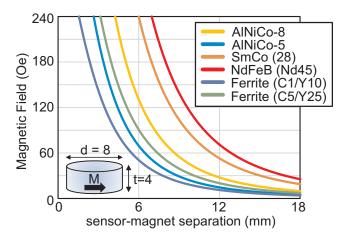


Figure 9. Magnetic fields from an 8 millimeter diameter, 4 millimeter thick magnet for increasing magnet-sensor separation. NdFeB materials produce the largest magnetic fields and separations. SmCo and AlNiCo materials offer the highest operating temperatures. Ferrite magnets are the most cost-effective.

Our free Web app can be used to determine the optimum separations for various magnet sizes and materials: <a href="https://www.nve.com/spec/calculators.php">https://www.nve.com/spec/calculators.php</a>.

NVE's Online Store stocks popular magnets.



## **Application Circuits**

## Typical Microcontrollers Interface

A typical microcontroller interface is shown below:

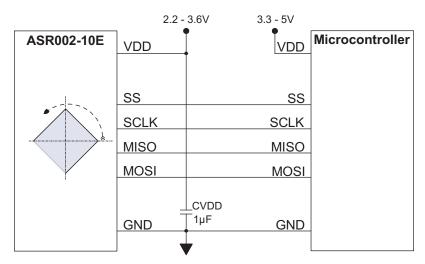


Figure 10. Typical microcontroller interface.

The ASR002 is configured as a Slave and the microcontroller should be configured as the Master. The ASR002 SPI interface is compatible with 3.3 or five-volt microcontrollers.



## Typical Read and Write Communications Pseudocode

```
//SPI clock set elsewhere (2 MHz max.)
//SPSR = SPI Status Register; SPIF = SPI Status Register Interrupt flag
//SS set low (active) elsewhere
      {
      case COMM_GET_MEM:
                                 //Routine to READ memory
SPDR=buffer[1];
                                 //Sends the address to read from
while(! (SPSR & (1<<SPIF)));
                                 //Waits for transmission
_delay_us(3);
                                 //Allow 3 microseconds between address bytes
SPDR=0x00;
                                 //'0' for second address byte (indicates read)
while(! (SPSR & (1<<SPIF)));
                                 //Waits for transmission
_delay_us(10);
                                 //Allows 10 microseconds for the address to be sent
SPDR=0x00;
while(! (SPSR & (1<<SPIF)));
                                //Waits for transmission to complete
                                 //Allows 10 microseconds for data to be sent
_delay_us(10);
                                 //Reads the first byte of data (MSB)
MSB=SPDR;
SPDR=0x00;
while(!(SPSR & (1<<SPIF)));
_delay_us(10);
                                 //Allows 10 microseconds for data to be sent
                                 //Reads the second byte of data (LSB)
LSB=SPDR;
                                 //Stores data in the buffer
buffer[0]=MSB;
buffer[1]=LSB;
*output_len=2;
                                 //Number of bytes to transmit
break;
      case COMM_SET_MEM:
                                 //WRITE memory routine (to set sensor parameters)
                                 //Puts the address to read from in the buffer
SPDR=buffer[1];
while(! (SPSR & (1<<SPIF)));
                                 //Wait for transmission to be complete
                                 //Allow address byte to be sent
_delay_us(3);
SPDR=0x01;
                                 //'1' for second address byte (write bit)
                                 //Wait for transmission to complete
while(! (SPSR & (1<<SPIF)));
_delay_us(10);
                                 //Allows time for data to be sent
                                 //Read first data byte(MSB)
SPDR=buffer[2];
while(! (SPSR & (1<<SPIF)));
_delay_us(10);
                                 //Allows time for the data to be sent
SPDR=buffer[3];
                                 //Read second data byte(LSB)
while(! (SPSR & (1<<SPIF)));
delay ms(20);
                                 //Allows 20 MILLIseconds to write to nonvolatile memory
break;
```

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## **Illustrative Arduino Code for Continuous Read**

```
/****************************
Continuously read the angle from an NVE ASR002 Smart Angle Sensor
Arduino Uno connections: pin 10=SS; pin 11=MOSI; pin 12=MISO; pin 13=SCLK
******************************
#include <SPI.h>
int angle;
void setup() {
pinMode(10, OUTPUT); //Pin 10 = Sensor SS
SPI.begin ();
//Set clock rate at 2 Mbits/s; MSB first; Mode 0
SPI.beginTransaction(SPISettings(2000000, MSBFIRST, SPI_MODE0));
digitalWrite(CS, HIGH); //Disable to reset the sensor
digitalWrite(10, LOW); //Re-enable sensor
}
void loop() {
angle = (SPI.transfer (0)) << 8; //Send 0 for address angle; receive angle MSB</pre>
delayMicroseconds (3); //Allow 3 us between address bytes
angle |= SPI.transfer (0); //2nd address byte (0 for read); receive angle LSB
delayMicroseconds (10); //Allow 10 us for next data
}
```



#### Illustrative Arduino Code to Zero the Sensor

```
/********************************
Zeros an ASR002 at its current location to establish a "home position."
Arduino Uno connections: pin 11=MOSI; pin 12=MISO; pin 13=SCLK; pins 9 & 10=SS
Includes a simple procedure to read the angle.
#include <SPI.h>
int angle;
void setup() {
pinMode(10, OUTPUT); //Pin 10 = Sensor SS
SPI.begin ();
//Set clock rate to 2 Mbits/s; MSB first; Mode 0
SPI.beginTransaction(SPISettings(2000000, MSBFIRST, SPI_MODE0));
digitalWrite(10, HIGH); //Disable to reset the sensor
digitalWrite(10, LOW); //Re-enable sensor
//Read starting angle
SPI.transfer (0); //Send 0 for address angle to read starting angle
delayMicroseconds (3); //Allow 3 us between address bytes
angle = (SPI.transfer (0x41)) << 8; Read starting angle MSB and point to offset address
delayMicroseconds (3); //Allow 3 us between address bytes
angle |= SPI.transfer (1); //Read angle LSB; 2nd address byte = 1 for write
delayMicroseconds (10); //Allow 10 us for next data
//Reset offset
SPI.transfer (0); //Write offset MSB
delayMicroseconds (3); //Allow time between bytes
SPI.transfer (0); //Write offset LSB
delay (20); //20 ms NVM delay
//Write measured angle to offset parameter to zero the sensor
angle=getAngle(); //Read angle now that offset has been set to zero
SPI.transfer (0x41); //Point to offset address
delayMicroseconds (3); //Allow time between address bytes
SPI.transfer (1); //2nd address byte = 1 for write
delayMicroseconds (10);
SPI.transfer (0x41); //Write to offset parameter to zero the sensor
delayMicroseconds (3);
SPI.transfer (angle & 0xFF); //Write LSB
delay (20); //20 ms NVM delay
void loop() {}
//Procedure to read the angle
int getAngle(){
int angle;
angle = (SPI.transfer (0)) << 8; //Send 0 for address angle; receive angle MSB
delayMicroseconds (3); //Allow 3 us between address bytes
angle |= SPI.transfer (0); //2nd address byte (0 for read); receive angle LSB
delayMicroseconds (10); //Allow 10 us for next data
return angle;
}
```



## In Case of Difficulty

#### Random data, or measured angles outside the allowable 0 to 3600 range.

- The SPI clock may be too fast (the ASR002 maximum clock rate is specified as 2 Mbits/s).
- Ensure the Master is operating in the correct mode (Mode 0).

## Random data, or measured angles outside the allowable 0 to 3600 range on the first readings after the sensor is selected.

The sensor is reset on a falling edge of SS. Toggling SS HIGH, then LOW will ensure the sensor is reset.

#### MSB/LSB bytes are reversed.

The MSB should be read first. SPI devices use different byte orders, but the ASR002 follows the most common convention of MSB first.

#### Angle data is shifted by one or more bits.

This is usually because the sensor has not completed internal shifting of bits into the correct positions. Ensure there is enough settling time between writing the address and reading the data (10 µs minimum).

#### Garbled data on first startup of Master.

Data can be left in the sensor if the Master microcontroller is reset and the sensor is not. This can be corrected by doing a "dummy read" as part of the microcontroller startup sequence, or toggling SS HIGH then LOW to reset the sensor.

#### Parameters do not appear to be written correctly.

- Ensure that the Write bit is set in the second (LSB), i.e., the second address byte is a "1."
- Ensure there is adequate settling time before reading or using a written parameter (10 milliseconds minimum). Parameters are stored in nonvolatile memory, not RAM, and writing to nonvolatile memory is much slower.

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## **Evaluation Support**

#### **Smart Angle Sensor Evaluation Kit**

This simple board includes an ASR002-10E Smart Angle Sensor, a microcontroller that interfaces to the Sensor via SPI, and to a PC via USB. The kit includes a diametrically-magnetized cylindrical horseshoe magnet and fixturing. A PC-based user interface provides two-way communication with the sensor to display the sensor outputs and change the sensor's parameters.



Figure 11. AG956-07E: Smart Angle Sensor Evaluation Kit.

#### Socket Board

The AG954-07E provides a TDFN6 socket for easy interface to sensors such as the ASR002-10E without soldering:

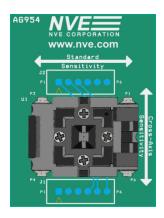


Figure 12. AG954-07E: TDFN socket board 1.5" x 2" (38 mm x 50 mm)(actual size)

#### **Bare Circuit Board**

The AG035-06 bare circuit board provides easy connections to TDFN6 devices such as the ASR002-10E:



Figure 13. AG035-06 TDFN6 bare circuit board 1.57" x 0.25" (40mm x 6 mm) (actual size).



#### Magnets

NVE stocks five popular magnets for use with its angle sensors:

NVE Part Number	Compatible Magnet Holder	Diameter (mm)	Length (mm)	Typ. sensor distance (mm; 120 Oe nom. field)	Material and Configuration
12526	4 mm	4	4	3	
12249	N/A	12.5	3.5	4	C5/Y25 ferrite
12527	8 mm	8	4	5	disk magnets
12528	8 mm	8	8	6	
12426*	N/A	11	11	8	Alnico-5 round horseshoe magnet with mounting hole

<sup>\*</sup>Included in the AG956-07E Smart Angle Sensor Evaluation Kit.

Table 2. Popular magnets for angle sensing.

#### **Magnet Holders**

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NVE offers two magnet holders for evaluation and prototyping. The holders are machined aluminum. Set screws secure the magnets in the holders and allow magnet position adjustments. There are threaded mounting holes for a thumbscrew to turn the magnet, or the hole can be used to attach the holder to a rotating shaft. A "clockhand" indicator helps track magnet rotation:

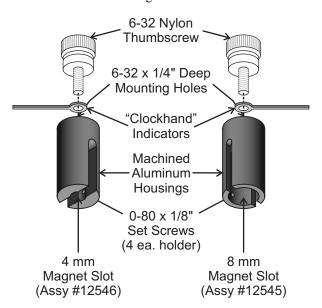


Figure 14. 4 mm magnet holder (part #12546; left) and 8 mm magnet holder (part #12545; right).

0.44" dia. x 0.88" tall (11 mm x 22 mm) outside dimensions; actual size).

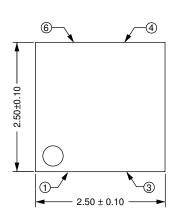
The holders are compatible with several popular diametrically-magnetized disk magnets and can be used in the AG956-07E Evaluation Kit:

Holder		Compatible	Magnet	Max. Magnet
Part	Outside	Magnets	Diameter	Length
Number	Dimensions	(NVE part #s)	(mm)	(mm)
12546	11 mm dia. x	12526	4	4
12545	22 mm tall	12527; 12528	8	8

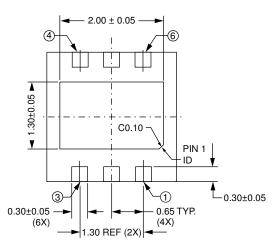
Table 3. Magnet holders.

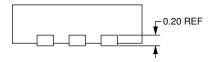


## 2.5 x 2.5 mm TDFN6 Package









Pad	Symbol	Description
1	GND	Ground/V <sub>ss</sub>
2	SCLK	SPI Clock Input
3	MISO	Sensor SPI Data Output
4	VDD	Power Supply (bypass with a 0.1µF capacitor)
5	MOSI	Sensor SPI Data Input
6	SS	Sensor Select Input (low to select)
Center pad		Internal leadframe connection; connect to GND to minimize noise.

## **Notes:**

- Dimensions in millimeters.
- Soldering profile per JEDEC J-STD-020C, MSL 1.





## **Ordering Information**

# ASR002 - 10E TR13

## **Product Family**

ASR = Smart Angle Sensors

## **Base Part Number**

002 = High speed, medium accuracy

## Field Range Identifier

Blank = General Purpose (60 to 200 Oe)

## **Part Package**

10E = RoHS-Compliant 2.5 x 2.5 mm TDFN6 Package

## **Bulk Packaging**

TR13 = 13" Tape and Reel Package





**Revision History** 

SB-00-081-F

• Recommend 1 μF rather than 0.1 μF bypass capacitor.

SB-00-081-E

Feb. 2019

April 2019

Change

• Improved "Magnet Selection" section.

• Added magnet and magnet holder information (p. 18).

SB-00-081-D

Feb. 2019

• Added details on center pad and grounding recommendation to minimize noise.

**SB-00-081-C** Jan. 2019

Change

Change

Change

• Faster RAM timing.

• Reduced data transfer rate from 2.5 to 2 Mbits/s for more design margin.

• Corrected number of bits in angular offset.

• Added Arduino code to zero the Sensor.

• Added "In Case of Difficulty" section

• Dropped daisy-chained SPI application diagram (not supported).

• Added AG954-07E socket board.

• Typographic and cosmetic changes.

SB-00-081-B

Jan. 2019

Change

• Added typical communications pseudocode.

• Typographic and cosmetic changes.

SB-00-081-A

Jan. 2019

Change

• Expanded and updated SPI timing specifications.

• Added detailed SPI timing diagrams.

• Tightened typ. supply current specification to 4 mA.

• Revised minimum operating field to 60 Oe.

• Added sensor direction output and hysteresis parameter.

• Added raw Sin and Cos vector outputs.

• Added illustrative microcontroller code.

• Finalized pinout.

• Added evaluation kit and board.

• Dropped customer calibration capability (unnecessary).

Various typographic corrections.

• "Rev. A" release.

**SB-00-081-PRELIM** 

Oct. 2018

Change

• Preliminary release.

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